Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

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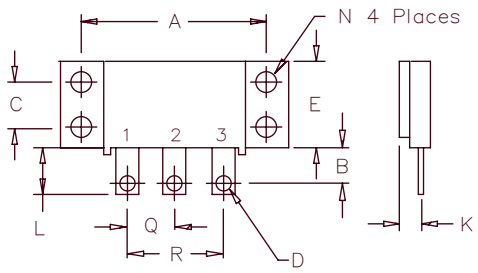
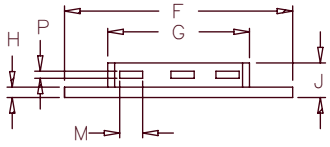
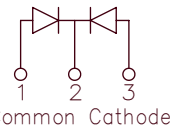
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

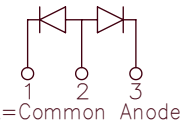
Schottky Powermod

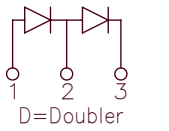
FST16090 – FST160100











Notes:
Baseplate: Nickel plated copper; electrically isolated
Pins: Nickel plated copper

Dim.	Inches		Millimeters		
	Min.	Max.	Min.	Max.	Notes
A	1.995	2.005	50.67	50.93	
B	0.300	0.325	7.62	8.26	
C	0.495	0.505	12.57	12.83	
D	0.182	0.192	4.62	4.88	Dia.
E	0.990	1.010	25.15	25.65	
F	2.390	2.410	60.71	61.21	
G	1.500	1.525	38.10	38.70	
H	0.120	0.130	3.05	3.30	
J	---	0.400	---	10.16	
K	0.240	0.260	6.10	6.60	to Lead ℄
L	0.490	0.510	12.45	12.95	
M	0.330	0.350	8.38	6.90	
N	0.175	0.195	4.45	4.95	Dia.
P	0.035	0.045	0.89	1.14	
Q	0.445	0.455	11.30	11.56	
R	0.890	0.910	22.61	23.11	

TO–249

Microsemi Catalog Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
FST16090*	90V	90V
FST160100*	100V	100V

*Add the Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring for Reverse Protection
- V_{RRM} – 90 to 100 Volts
- High Surge Capacity
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$ 160 Amps	T_C = 120°C, Square wave, $R_{\theta JC}$ = 0.5°C/W
Average forward current per leg	$I_{F(AV)}$ 80 Amps	T_C = 120°C, Square wave, $R_{\theta JC}$ = 0.9°C/W
Maximum surge current per leg	I_{FSM} 1200 Amps	8.3 ms, half sine T_J = 175°C
Max repetitive peak reverse current per leg	$I_{R(OV)}$ 2 Amps	f = 1 KHz, 25°C, 1μsec Square wave
Max peak forward voltage per leg	V_{FM} .75 Volts	I_{FM} = 80A: T_J = 175°C*
Max peak forward voltage per leg	V_{FM} .96 Volts	I_{FM} = 80A: T_J = 25°C*
Max peak reverse current per leg	I_{RM} 30 mA	V_{RRM}, T_J = 125°C*
Max peak reverse current per leg	I_{RM} 2 mA	V_{RRM}, T_J = 25°C
Typical junction capacitance per leg	C_J 1500 pF	V_R = 5.0V, T_J = 25°C

*Pulse test: Pulse width 300μsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range	T_{STG}	–55°C to 175°C
Operating junction temp range	T_J	–55°C to 175°C
Maximum thermal resistance per leg	$R_{\theta JC}$	0.9°C/W Junction to case
Max thermal resistance per pkg.	$R_{\theta JC}$	0.5°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.1°C/W Case to sink
Mounting torque		15 – 20 inch pounds
Weight		2.5 ounces (71 grams) typical

FST16090 – FST160100

Figure 1
Typical Forward Characteristics

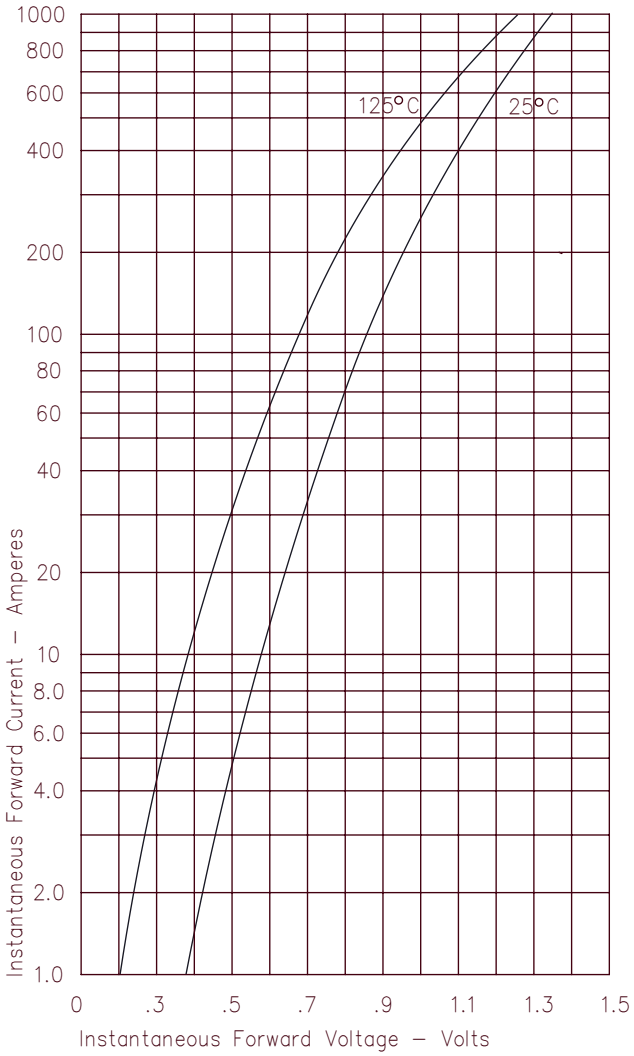


Figure 2
Typical Reverse Characteristics

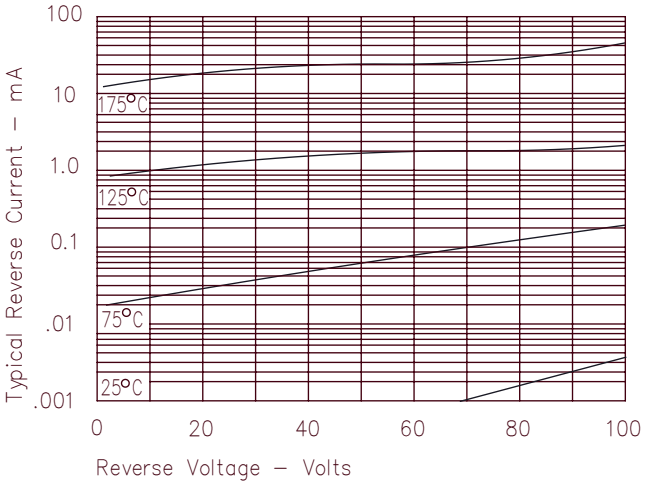


Figure 3
Typical Junction Capacitance

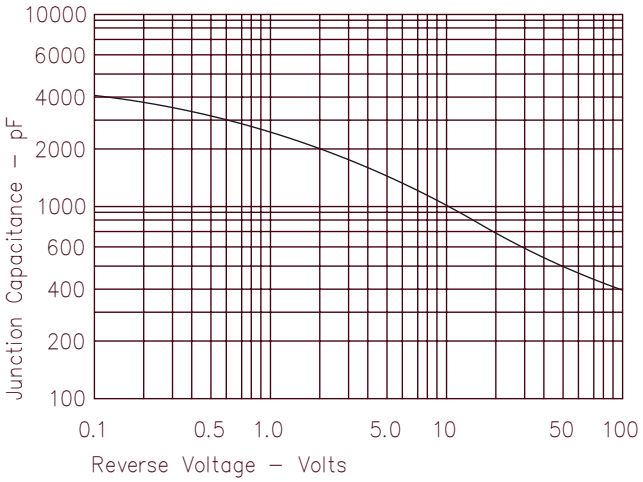


Figure 4
Forward Current Derating

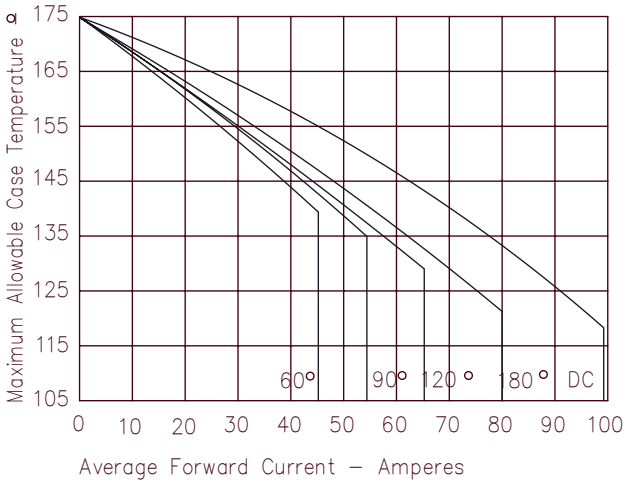
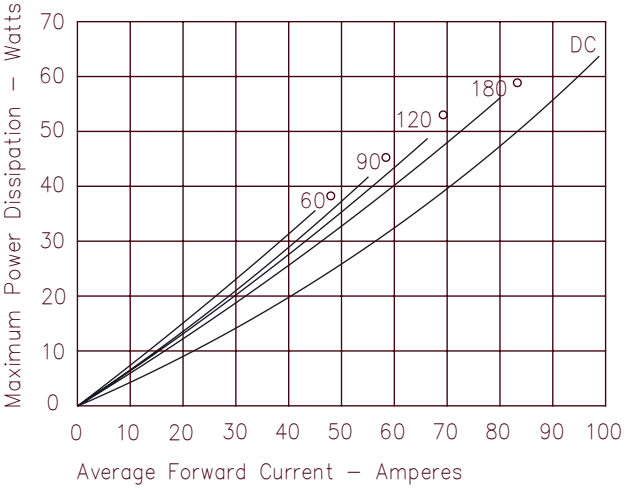


Figure 5
Maximum Forward Power Dissipation



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